

## Product environmental attributes – THE ECO DECLARATION

The declaration may be published only when all rows and/or fields marked with an \* are filled-in (n.a. for not applicable). Additional information regarding each item may be found under P14.

Brand *	ThinkCentre	Logo
Company name *	Lenovo	
Contact information *	Alvin L Carter 1009 Think Place Building 2 / 5J3 Morrisville, North Carolina 27560 alcarter@lenovo.com	lenovo
Internet site *	www.pc.ibm.com/ww/lenovo/about/environment	·
Additional information		

	pased on product specification or test results based obtained from sample testing), that the product is given in this declaration.		
Type of product *	Personal Computer		
Commercial name *	ThinkCentre M90/M90p		
Model number *	Tower: 3029, 3139, 3246, 3349, 3544, 5474, 5554, 5384,		
	3054, 3219, 3282, 3421, 3652, 5498, 5852, 5450, 6232, 6590		
Issue date *	010, January 05		
Intended market *	Global 🔲 Europe 🔄 Asia, Pacific & Japan 🔛 Americas 🔛 Other		
Additional information	ENERGY STAR® 5.0 Qualified; EPEAT Gold Rating, GREENGUARD Certification		

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Quality Control			Requirement met		
Item		Yes	No		
QC1 *	The company enforces an internal quality control scheme to ensure the correctness of this eco declaration	$\boxtimes$			
QC2 *	The company is a member of an eco declaration system that enforces regular independent quality contro such as organized by IT-Företagen (see www.itecodeclaration.org).	ol 🔀			

Model number *	ThinkCentre M90/M90p Tower: 3029, 31	39, 324	6, 3349	), 3544, 5474, 5554,
	5384, 3054, 3219, 3282, 3421, 3652, 5498, 5852, 5450, 62	232, 659	0	
Issue date *	2010, January 05	L	Logo	lenovo

Product	t environmental attributes - Legal requirements	Require	ement	met
Item		Yes	No	n.a.
P1	Hazardous substances and preparations			
P1.1*	Products do not contain more than; 0.1% lead, 0.01% cadmium, 0.1% mercury, 0.1% hexavalent chromium, 0.1% polybrominated biphenyls (PBB) or 0.1% polybrominated diphenyl ethers (PBDE). (See legal reference and Note B1)			
P1.2*	Products do not contain Asbestos (see legal reference). Comment: Legal reference has no maximum concentration value.	$\bowtie$		
P1.3*	Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1- trichloroethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum concentration values.			
P1.4*	Products do not contain more than; 0.005% polychlorinated biphenyl (PCB), 0.005% polychlorinated terphenyl (PCT) in preparations (see legal reference).	$\boxtimes$		
P1.5*	Products do not contain more than 0.1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the chain containing at least 48% per mass of chlorine in the SCCP (see legal reference).	$\square$		
P1.6*	Textile and leather parts with direct skin contact do not contain Tri-(2,3,-dibromopropyl)-phosphate (TRIS), Tris-(aziridinyl)-phosphineoxide (TEPA), polybrominated biphenyl (PBB) (see legal reference). Comment: Legal reference has no maximum concentration values.			
P1.7*	Textile and leather parts with direct skin contact do not contain more than 0.003% Azo colorants that split aromatic amines. (See legal reference and Note B1)			$\boxtimes$
P1.8*	Wooden parts do not contain arsenic and chromium as a wood preservation treatment as well as pentachlorophenol and derivatives (see legal reference). Comment: Legal reference has no maximum concentration values.			
P1.9*	Parts with direct and prolonged skin contact do not release nickel in concentrations above 0.5 microgram/cm <sup>2</sup> /week (see legal reference). Comment: Max limit in legal reference when tested according to EN1811:1998.			
P1.10*	REACH Article 33 information about substances in articles is available at (add URL or mail contact): http://www.lenovo.com/social_responsibility/us/en/environment.html	$\square$		
P2	Batteries			
P2.1*	If the product contains a battery or an accumulator, it is labeled with the disposal symbol and if it contains more than 0.0005% of mercury (for button cells only) by weight, or more than 0.004% of lead, it shall be marked with the chemical symbol for the metal concerned, Hg or Pb. Information on proper disposal is provided in user manual. (See legal reference)			
P2.2*	Button cells used in the product do not contain more than 2% by weight of mercury. Other batteries or accumulators do not contain more than 0.0005% of mercury or 0.002% of cadmium. (See legal reference)	$\boxtimes$		
P2.3*	Batteries and accumulators are easily removable by either users or service providers (as dependent on the design of the product). Exception: Batteries that are permanently installed for safety, performance, medical or data integrity reasons do not have to be "easily removable". (See legal reference)			
P3	Safety, EMC connection to the telephone network and labeling			
P3.1*	The product complies with legally required safety standards as specified (see legal reference).	$\square$		
P3.2*	The product complies with legally required standards for electromagnetic compatibility (see legal reference).			
P3.3*	If product is intended for connection to a public telecom network or contains a radio transmitter, it complies with legally required standards for radio and telecommunication devices (see legal reference).			
P3.4*	The product is labeled to show conformance with applicable legal requirements (see legal reference).	$\boxtimes$		
P4	Consumable materials			
P4.1*	If a photo conductor (drum, belt etc.) is used in the product, it does not contain cadmium max 0.01% (see legal reference and Note B1).			$\boxtimes$
P4.2*	If ink/toner is used in the product, it does not contain cadmium max 0.1% by weight (see legal reference).			$\boxtimes$
P4.3*	If the ink/toner formulation/preparation is classified as hazardous according to applicable regulations, the product/packaging is adequately labeled and a Safety Data Sheet (SDS) in accordance with these requirements is available (see legal reference).			
P5	Product packaging			
P5.1*	Packaging and packaging components do not contain more than 0.01% lead, mercury, cadmium and hexavalent chromium by weight of these together.			
P5.2*	Plastic packaging material is marked according to ISO 11469 referring ISO 1043 (see legal reference).	$\boxtimes$		
P5.3*	The product packaging material is free from ozone depleting substances as specified in the Montrea Protocol (see legal reference). Comment: Legal reference has no maximum concentration values.			

Note B1: Restriction applies to the homogeneous material, unless other specified and expressed in weight %.

tem       *-mandatory to III in Additional Information regarding each item may be found under P14.       Yes       No         Performation       Important information       Important information       Important information         Performation       Important information       Important information       Important information         Price       Plastic materials in covershousing have no surface coating.       Important information       Important information         Price       Plastic parts >100 gconsist of one material or of easily separable materials.       Important information       Important information         Price       Plastic parts >25 plast material or of easily separable materials.       Important information       Important information       Important information         Price       Plastic parts >25 plast material or of easily separable materials.       Important information       Important information       Important information         Price       Labels are easily separable. (This requirement dees not apply to safety/regulatory labels).       Important information       Important information         Price       Upgrading can be done using commonly available tools       Important information       Important information       Important information         Price       Material type:       Material type:       Material type:       Important information       Important information       Important information	Logo       Requirement met         ket requirements - Environmental conscious design       Requirement met         rmation regarding each item may be found under P14.       Yes       No       n.a.         acilities is available (see legal reference).       Image: Construction of the second sec		
tem       *=mandatory to fill in . Additional information regarding each item may be found under P14.       Yes       No         P6       Treatment information       Image: Second	rmation regarding each item may be found under P14. Yes No n.a. acilities is available (see legal reference).		
team       *=mandatory to III in Additional information regarding each item may be found under P14.       Yes       No         P6       Treatment information       Image: Second Se	rmation regarding each item may be found under P14. Yes No n.a. acilities is available (see legal reference).		
P6.1*       Information for recyclers/treatment facilities is available (see legal reference).       ☑         P7       Design Disassemby, recycling       ☑         P7.1*       Parts that have to be treated separately are easily separable       ☑         P7.2       Plastic materials in covers/housing have no surface coating.       ☑         P7.3*       Plastic parts 320 points of one material or of easily separable materials.       ☑         P7.4*       Plastic parts 320 points of one material or of easily separable materials.       ☑         P7.4*       Plastic parts 320 pave material acode saccording to ISO 11469 referring ISO 1043.       ☑         P7.4*       Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools.       ☑         P7.6*       Upgrading can be done e.g. with processor, memory, cards or drives       ☑         P7.7*       Upgrading can be done e.g. with processor, memory, cards or drives       ☑         P7.9*       Spare parts are available after end of production for: 5 years         P7.10*       Service is available after end of production for: 5 years         P7.11*       Product cover/housing materials of signal cables are PVC free       ☑         P7.14       Id cover/housing materials of signal cables are PVC free       ☑         P7.14       All coverthousing plastic parts >25g are free from chiorine and bromine.<	tely are easily separable		
Pr         Design         Design           P7.1         Parts that have to be treated separately are easily separable         Image: Control of Co	tely are easily separable		
Disassembly, recycling         Image: Control of the treated separately are easily separable         Image: Control of the treated separately are easily separable           P11         Parts that have to be treated separately are easily separable materials.         Image: Control of the treated separately are easily separable materials.         Image: Control of the treated separately are easily separable materials.         Image: Control of the treated separately control of the treated separately is that can be removed with commonly available tools.         Image: Control of the treated separately control of the treated separately is the treateriated			
P7.11       Parts that have to be treated separately are easily separable       □         P1.22       Plastic materials in covers/housing have no surface coating.       □         P7.37       Plastic parts > 200 consist of one material or of easily separable materials.       □         P7.3       Plastic parts > 25g have material codes according to ISO 11469 reterring ISO 1043.       □         P7.5       Plastic parts set free from metal inlays or have inlays that can be removed with commonly available tools.       □         P7.6       Labels are easily separable. (This requirement does not apply to safety/regulatory labels).       □         P7.7       Upgrading can be done e.g. with processor, memory, cards or drives       □         P7.7       Upgrading can be done e.g. with processor, memory, cards or drives       □         P7.10       Spare parts are available after end of production for: 5 years         P7.11       Product over/housing material type:       Material tradit over and substance requirements         P7.12       Electrical cable insulation materials of signal cables are PVC free.       □         P7.13       Electrical cable insulation materials of signal cables are PVC free.       □         P7.14       Product boards (without components) >25g are free from chlorine and bromine.       □         P7.14       All cover/housing plastic parts >25g in covers / housings are marked according ISO 1043.4:			
P7.2       Plastic materials in covers/housing have no surface coating.       Image: Construction of the construction			
P7.3*       Plastic parts >100g consist of one material or of easily separable materials.       Image: Constraint of the image: Constraint of the image: Constraint of the image: Constraint of the image: Constraint one one of the image: Constraint one one of the image: Constraint one	nave no surrace coating		
P7.4*       Plastic parts >26g have material codes according to ISO 11469 referring ISO 1043.       Image: Content of Conten of Content of Content of			
P7.5       Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools.       Image: Commonly available atter can be removed with commonly available tools.         P7.6       Labels are easily separable. (This requirement does not apply to safety/regulatory labels).       Image: Commonly available atter can be one e.g. with processor, memory, cards or drives         P7.8       Upgrading can be done e.g. with processor, memory, cards or drives       Image: Commonly available atter can d production for: 5 years         P7.10       Service is available after end of production for: 5 years       Image: Commonly available atter can d production for: 5 years         P7.11       Product cover/housing material type:       Material type: P1.12         P7.12       Electrical cable insulation materials of signal cables are PVC free.       Image: Commons.         P7.13       Electrical cable insulation materials of signal cables are PVC free.       Image: Commons.         P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.       Image: Commons.         P7.14       All cover/housing plastic parts >25g in covers / housings are marked according ISO 1043-4:       Image: Commons.         P7.15       All printed circuit boards (without components):       Image: Commons.       Image: Commons.         P7.16       Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%:       Image: Commons.			
P7.6*       Labels are easily separable. (This requirement does not apply to safety/regulatory labels).       Image: Constraint of the image: Constraint on the image: Constraint the image: Constraint the image: Constraint			
Product lifetime       Image: Second Se			
P7.7*       Upgrading can be done e.g. with processor, memory, cards or drives       □         P7.8       Upgrading can be done e.g. with processor, memory, cards or drives       □         P7.9       Spare parts are available after end of production for: 5 years       □         P7.10       Service is available after end of production for: 5 years       □         Material and substance requirements       P7.11       Product cover/housing materials of signal cables are PVC free.       □         P7.12       Electrical cable insulation materials of signal cables are PVC free.       □       ○         P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.       ○       ○         P7.14       All cover/housing plastic parts >25g in covers / housings are marked according ISO 1043-4:       □       ○         P7.17       Alt. 1       Chemical specifications of flame retardants in printed circuit boards >25g (without components):       □       □         P7.18       Alt. 1       Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4:       □         P7.18       Alt. 1       Flame retarded plastic parts >25g orotain the following flame retardant substances/preparations in concentrations above 0.1%:       □         Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4:       □ <td></td>			
P7.8'       Upgrading can be done using commonly available tools       X         P7.9       Spare parts are available after end of production for: 5 years         Material and substance requirements         P7.10       Service is available after end of production for: 5 years         Material and substance requirements         P7.11       Product cover/housing material type: Material type: ABS         Material type: ABS       Material type: Material type:         P7.12       Electrical cable insulation materials of signal cables are PVC free.         P7.13       Electrical cable insulation materials of signal cables are PVC free.         P7.14       All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note 82)         P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Matking:         P7.17       Alt. 1         Chemical specifications of flame retardants in printed circuit boards (without components): TBBPA (additive)       TBBPA (reactive)         X       Dimension specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14         P7.18       Alt. 1         Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%:       Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retar	cessor, memory, cards or drives		
P7.9.       Spare parts are available after end of production for: 5 years         P7.10       Service is available after end of production for: 5 years         Material and substance requirements         P7.11       Product cover/housing materials uppe: Material type: ABS         Material type: ABS       Material type:         P7.12       Electrical cable insulation materials of gower cables are PVC free.         P7.13       Electrical cable insulation materials of signal cables are PVC free.         P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.         P7.15       All cover/housing plastic parts >25g in covers / housings are marked according ISO 1043-4:         Matring:       P7.16         F1.7       All and retarded plastic parts >25g in covers / housings are marked according ISO 1043-4:         Matring:       P7.17         P7.17       Alt. 1         Chemical specifications of flame retardants in printed circuit boards (without components): TBBPA (additive)       Other; chemical name:         P7.18       Alt. 1         P1.18       Alt. 1         P1.18       Alt. 1         P1.19       Flame retarded plastic parts >25g ontain the following flame retardant substances/preparations in concentrations above 0.1%:         Comment: 0.043.4: Brominated Epoxy Resin See P14         P7.18       Alt.			
P7.10       Service is available after end of production for: 5 years         Material and substance requirements         P7.11       Product cover/housing material type:         Material type: ABS       Material type:         Material type: ABS       Material type:         P7.12       Electrical cable insulation materials of power cables are PVC free.       ○         P7.13       Electrical cable insulation materials of signal cables are PVC free.       ○         P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.       ○         P7.15       All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2)       ○         P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4:       ○         Marking:       P7.17       Alt.1       Chemical specifications of flame retardants in printed circuit boards >25g (without components):       □         TBBPA (additive)      TBBPA (reactive)      O ther; chemical name:      CAS #:         Alt. 2       Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4:       □         P7.16       Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%.       □         Chemical specifications of flame r			
Material and substance requirements         P7.11       Product cover/housing material type: Material type: ABS       Material type: Material type: P7.12       Electrical cable insulation materials of power cables are PVC free.       X         P7.13       Electrical cable insulation materials of signal cables are PVC free.       X         P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.       X         P7.15       All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2)       X         P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking:       X         P7.17       Alt. 1       Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive)       TBBPA (reactive)       Other; chemical name: . CAS #:         P7.18       Alt. 1       Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical aneme:			
P7.11*       Product cover/housing material type: Material type: ABS       Material type: Material type: Material type: Material type: Material type: Material type: ABS         P7.12       Electrical cable insulation materials of power cables are PVC free       Image: Source and			
Material type:       Material type:       Material type:         P7.12       Electrical cable insulation materials of power cables are PVC free       Image: Comparison of Comp			
P7.13       Electrical cable insulation materials of signal cables are PVC free       □         P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.       □         P7.15       All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2:21. (See Note 82)       □         P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4:       □         Marking:       □       □         P7.17       Alt. 1       Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) □, TBBPA (reactive) ☑, Other; chemical name: , CAS #:       □         Alt. 2       Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14       □         P7.18       Alt. 1       Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier:       □         2. Chemical name: , CAS #: , Supplier:       □       □         3. Chemical name: , CAS #: , Supplier:       □       □         4. Q. R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)       □         P7.20       Of total plastic pa	Material type: Material type:		
P7.14       All cover/housing plastic parts >25g are free from chlorine and bromine.       □         P7.15       All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2)       □         P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4:       □         Marking:       □       □         P7.17       Alt. 1       □         Chemical specifications of flame retardants in printed circuit boards >25g (without components):       □         TBBPA (additive)       □, TBBPA (reactive)       ○, Other; chemical name:, CAS #:         Alt. 2       Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14         P7.18       Alt. 1       Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%:       □         Comment: No legal limits exist, this is a market requirement.       Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name:, CAS #:, Supplier:       2.         2. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:       □         P7.19       Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)       □ <td>of power cables are PVC free.</td>	of power cables are PVC free.		
P7.15       All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2)         P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4:         Marking:	of signal cables are PVC free		
Note B2)       P7.16       Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking:         P7.17       Alt. 1       Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) □, TBBPA (reactive) ☑, Other; chemical name: , CAS #:         Alt. 2       Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14         P7.18       Alt. 1         Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%:         Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 3. Chemical apecifications of flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.20       Of total plastic parts '>25g, icocycled material content is 0%.         P7.21       Of total plastic parts '>25g, icocycled material content is 0%.         P7.22       Light so	are free from chlorine and bromine.		
Marking:       Marking:         P7.17       Alt. 1         Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) □, TBBPA (reactive) ☑, Other; chemical name: , CAS #:         Alt. 2         Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14         P7.18       Alt. 1         Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%:         Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4.t. 2         Chemical specifications of flame retardant substances/ preparations above 0.1%: Chemical specifications of flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.19       Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.20       Of total plastic parts '25g, biobased material content is +25%.         P7.21       Of total plastic parts' weight >25g, biobased material content is %2%.         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury conte	omponents) >25g are halogen free. as defined in IEC61249-2-21. (See		
Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) □, TBBPA (reactive) ☑, Other; chemical name: , CAS #:         Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14         P7.18       Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name; CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4.t. 2         P7.19       Plastic parts >25g are free from flame retardant substances/ preparations of that eretardant substances/ preparations above 0.1% Commer (CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4.t. 2         P7.19       Plastic parts >25g are free from flame retardants in plastic parts >25g according ISO 1043-4:         P7.19       Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.20       Of total plastic parts' weight >25g, recycled material content is +25%.         P7.21       Of total plastic parts' weight >25g, tobased material content is 0%.         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg         P8       Batteries	covers / housings are marked according ISO 1043-4:		
Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14         P7.18       Alt. 1         Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%:       □         Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4.t. 2       □         P7.19       Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)       □         P7.20       Of total plastic parts' weight >25g, recycled material content is +25%.       □         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg       □         P8       Batteries       □         P8.1*       Battery chemical composition: Lithium Manganese Dioxide			
Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: <ul> <li>Comment: No legal limits exist, this is a market requirement.</li> <li>Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier.</li> <li>1. Chemical name: , CAS #: , Supplier:</li> <li>2. Chemical name: , CAS #: , Supplier:</li> <li>3. Chemical name: , CAS #: , Supplier:</li> <li>Alt. 2</li> <li>Chemical specifications of flame retardants in plastic parts &gt;25g according ISO 1043-4:</li> </ul> <li>P7.19 Plastic parts &gt;25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)</li> <li>P7.20 Of total plastic parts' weight &gt;25g, recycled material content is +25%.</li> <li>P7.21 Of total plastic parts' weight &gt;25g, biobased material content is 0%.</li> <li>P7.22 Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg</li> <li>P8 Batteries</li> <li>P8.1* Battery chemical composition: Lithium Manganese Dioxide</li>			
Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier.         1. Chemical name:       , CAS #:       , Supplier:         2. Chemical name:       , CAS #:       , Supplier:         3. Chemical name:       , CAS #:       , Supplier:         3. Chemical name:       , CAS #:       , Supplier:         Alt. 2       Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:         P7.19       Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.20       Of total plastic parts' weight >25g, recycled material content is +25%.         P7.21       Of total plastic parts' weight >25g, biobased material content is 0%.         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg         P8       Batteries         P8.1*       Battery chemical composition: Lithium Manganese Dioxide	ig contain the following flame retardant substances/preparations in		
Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:       Image: Chemical specifications of flame retardant substances/ preparations above 0.1% classified as R45, R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.20       Of total plastic parts' weight >25g, recycled material content is +25%.         P7.21       Of total plastic parts' weight >25g, biobased material content is 0%.         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg         P8       Batteries         P8.1*       Battery chemical composition: Lithium Manganese Dioxide	rdants including MSDS for each flame retardant. The list must contain ber and supplier. , Supplier:		
R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)         P7.20       Of total plastic parts' weight >25g, recycled material content is +25%.         P7.21       Of total plastic parts' weight >25g, biobased material content is 0%.         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg         P8       Batteries         P8.1*       Battery chemical composition: Lithium Manganese Dioxide			
P7.21       Of total plastic parts' weight >25g, biobased material content is 0%.         P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg         P8       Batteries         P8.1*       Battery chemical composition: Lithium Manganese Dioxide			
P7.22       Light sources are free from mercury If mercury is used specify: Number of lamps: and max. mercury content per lamp: mg         P8       Batteries         P8.1*       Battery chemical composition: Lithium Manganese Dioxide			
If mercury is used specify: Number of lamps:       and max. mercury content per lamp:       mg         P8       Batteries       Easterney       Easterney         P8.1*       Battery chemical composition: Lithium Manganese Dioxide       Easterney			
P8.1* Battery chemical composition: <i>Lithium Manganese Dioxide</i>			
	un Manuanaa Diavida		
P8.2 Batteries meet the requirements of the following voluntary program/s:	um Manganese Dioxide		

Note B2: IEC61249-2--21 has maximum limits for chlorine and bromine but does not address fluorine, iodine and astatine which are included in the group of halogens.

Note B3: 'Starting from January 2009, Risk phrases can be replaced by Hazard phrases according to the Globally Harmonized System (GHS), mandatory by December 2010.

Model number *	ThinkCentre M90/M90p Tower: 3029, 3139, 32	246, 334	9, 3544, 5474, 5554,
	5384, 3054, 3219, 3282, 3421, 3652, 5498, 5852, 5450, 6232, 65	5 <b>9</b> 0	
Issue date *	2010, January 05	Logo	lenovo

Product	environmental a	ttributes - Market	requirements (co	ontinued)	Requirement	met
Item	-				Yes No	n.a.
P9	Energy consum					
9.1	For the product the	ne following power lev	els or energy consu	mptions are reporte	ed:	
Energy mo * Categor	ode <b>y D (see P14)</b>	Power level at 100 V AC	Power level at 115 V AC	Power level at 230 V AC	Reference / Standard for energy modes and test method *	
Peak (On	- max)	174.9 W	179.9 W	172.2 W	Full load	
Idle State	9	60.4 W	59.8 W	60.6 W	Idle State for ES	
Sleep(S3)	- WOL Enable	<b>2.16</b> W	<b>2.19</b> W	<b>2.61</b> W	Sleep Mode w/ WOL Enabled for ES	
Off(S4/S5	i) - WOL Enable	0.79 W	0.83 W	1.24 W	Off Mode w/ WOL Enabled for ES	
		W	W	W		
		W	W	W		
EPS No-lo	bad	W	W	W		
charger pl	power supply / ugged in the wall disconnected from ct.)					
P <sub>⊤EC</sub> Typical Er	nergy Consumption	W	W	W	(Workstation Levels) $P_{TEC} = 0.35^* P_{off} + 0.10^* P_{sleep} + 0.55^* P_{idle}$	
TEC Typical Er	nergy Consumption	kWh/week	kWh/week	kWh/week		
Etec * Annual Er	ergy Consumption	216.22 kWh/year	214.57 kWh/year	219.32 kWh/year	(Desktop, Integrated Desktop, and Notebook Levels) $E_{TEC} = (8760/1000) * (P_{off} * T_{off} + P_{sleep} * T_{sleep} + P_{idle} * T_{idle})$	
Display re	solution : N	/legapixels	ł	ł		
Print Spee	ed : I	mages per minute				
Default tin	ne to enter energy s	ave mode: 10 minute	s			H
P9.2*	0,	the energy save fund		the product.		⊢
P9.3*	•	ts the energy requirent oversion: Version 5.0		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	/s:	
P10	Emissions					
<u> </u>		<ul> <li>Declared according</li> </ul>	to ISO 9296			
P10.1	Mode	Mode description		Declared A-weighted sound power	Declared A-weighted sound pressure level $L_{p{\rm Am}}$ (dB)	P1 0.1
				level $L_{WAd}$ (B)	Operator position Desktop or Desk side	
	Idle	* HDD: Idle		* 3.5	24	
	Operation	* HDD: Operating		* 3.8	26	
	Other mode					
	Measured accord	ing to: 🔀 ISO7779	ECMA-74 (only if not covered	ed by ECMA-74 with	L <sub>pAm</sub> measurement distance m)	
P10.2	The product most		requirements of the f			

Model nui	mber *	<b>ThinkCentre M90/M90p</b> Tower: 3029, 3139, 3246, 5384, 3054, 3219, 3282, 3421, 3652, 5498, 5852, 5450, 6232, 6590	3349, 3544,	5474,	5554	4,
Issue date *		5384, 3054, 3219, 3282, 3421, 3652, 5498, 5852, 5450, 6232, 6590           2010, January 05	00			
Issue uale	2				vo	
Product	onvironn	nental attributes - Market requirements (continued)	P	equire	mont	mot
Item		nental attributes - Market requirements (continued)		Yes	No	n.a.
itoini	Chemica	al emissions from printing products		100		ma.
P10.3*		formed according to ECMA-328 (ISO/IEC 28360) standard , other specify:				$\square$
P10.4		emission rate (print phase) is (mg/h):				
		Dust Ozone Styrene Benzene TVOC				
P10.5	Chemica	I emission requirements of the following voluntary program/s are met for :				X
	C	Dust Ozone Styrene Benzene TVO	oc 🗌		-	
		nagnetic emissions				
P10.6	Compute program	er display meets the requirement for low frequency electromagnetic fields of the followir /s:	ig voluntary			$\square$
P11		hable materials for printing products		-		
P11.1*	-	Data Sheet (SDS) is available for the ink/toner preparation, even if not legally required				$\boxtimes$
P11.2*	EN1228		equirements of			$\square$
P11.3*	2-sided (	duplex) printing/copying is an integrated product function.				$\mathbb{X}$
P12		nics for computing products				
P12.1*	The disp	lay meets the ergonomic requirements of ISO 9241-307 for visual display technologies		$\bowtie$		
P12.2*	The phys	sical input device meets the requirements of ISO 9995 and ISO 9241-410.		$\boxtimes$		
P13		ng and documentation				
P13.1*	Product	packaging material type(s): <i>EPE</i> weight (kg): <i>0.3</i> packaging material type(s): <i>Corrugated</i> weight (kg): <i>1.67</i> packaging material type(s): weight (kg):				
P13.2*	Product	plastic packaging is free from PVC.		$\boxtimes$		
P13.3*		nedia for user and product documentation (tick box):				
P13.4*	For pape	er user and product documentation, please specify contained percentage of post-consu %(Japan only 70%)	mer recycled			
P14	Addition	nal information (See Note B4)				
	NOTE: informati knowledg provided informati	Supplier makes no representations, guarantees, assurances or warranties whether exp on contained in this document. All information provided by supplier in this document is ge available at the time of completion, and supplier shall have no obligation to update s here is approximate and provided for informational purposes only. See a Lenovo Acco on.	provided based uch information unt Representa	on supp . The inf	lier's ormati	
P7.17		does not contain free TBBPA in printed circuit boards(without components)>25g	1.			
P9		ergy Star Qualified Computers for the latest information: ww.energystar.gov/index.cfm?fuseaction=find_a_product.ShowProductGroup&p	gw_code=CO			
	configui * Greate	y D desktops will have: Greater than or equal to 4 Physical Cores. Models qualify red with a minimum of 1 of the following 2 characteristics: r than or equal to 4 gigabytes (GB) of System Memory; and/or rete GPU with a Frame Buffer Width greater than 128-bit.	/ing under Cate	egory D	are al	lso

## Legal references Europe Annex B

Reference	Declaration item
2002/95/EC (ROHS Directive)	P1.1, P4.1
REACH, Annex XVII	P1.6, P1.8, P4.2
REACH, Annex XVII	P1.4
REACH, Annex XVII	P1.2
REACH, Annex XVII	P1.7
REACH, Annex XVII	P1.9
Regulation (EC) No. 2037/2000, 2038/2000, 2039/2000	P1.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
2006/66/EC (Battery and accumulators Directive)	P2.1, P2.2, P2,3, P3.4, P8.1
2006/95/EC (Low Voltage Directive)	P3.1, 3.4
2004/108/EEC (New EMC Directive)	P3.2, 3.4
1999/5/EC (R&TTE Directive)	P3.3, 3.4
"REACH" Regulation (1907/2006), annex VII	P1.10
(EC) No.1272/2008 regulation on classification, labeling and packaging (CLP)	P4.3
REACH article 31, annex II	P4.3
2004/12/EC (Directive on packaging and packaging waste)	P5.1
(97/129/EC) (Commission Decision on Identification System for Packaging Materials	P5.2
2037/2000/EC Regulation on Substances that Deplete the Ozone Layer	P5.3
2002/96/EC (WEEE directive)	P3.4, P6.1
(EC) No.1272/2008 regulation on classification, labeling and packaging (CLP)	P7.19